SiA427ADJ

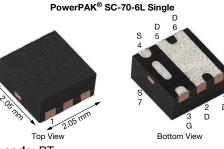
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**Vishay Siliconix** 

RoHS COMPLIANT

HALOGEN

FREE



Marking code: BT

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	-8			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -4.5 V	0.0160			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -2.5 V	0.0215			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -1.8 V	0.0260			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -1.5 V	0.0320			
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -1.2 V	0.0950			
Q <sub>g</sub> typ. (nC)	30			
I <sub>D</sub> (A) <sup>a</sup>	-12			
Configuration	Single			

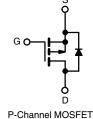
#### **FEATURES**

P-Channel 8 V (D-S) MOSFET

- TrenchFET<sup>®</sup> power MOSFET
- Thermally enhanced PowerPAK<sup>®</sup> SC-70 package - Small footprint area - Low on-resistance
- 100 % R<sub>a</sub> tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

 Load switch, for 1.2 V power line for portable and handheld devices



<b>ORDERING INFORMATI</b>	ON
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Package	PowerPAK SC-70
Lead (Pb)-free and halogen-free	SiA427ADJ-T4-GE3
	SiA427ADJ-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	-8	V	
Gate-source voltage		V <sub>GS</sub>	± 5	V	
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		-12 <sup>a</sup>		
	T <sub>C</sub> = 70 °C		-12 <sup>a</sup>	_	
	T <sub>A</sub> = 25 °C	I <sub>D</sub>	-12 <sup>a, b, c</sup>		
	T <sub>A</sub> = 70 °C		<b>-9.9</b> b, c	A	
Pulsed drain current (t = 300 µs)		I <sub>DM</sub>	-50		
	T <sub>C</sub> = 25 °C		-12 <sup>a</sup>	_	
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	-2.9 <sup>b, c</sup>		
	T <sub>C</sub> = 25 °C		19	w	
Maximum power dissipation	T <sub>C</sub> = 70 °C		12		
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.5 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		2.2 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	*0	
Soldering recommendations (peak temperature) <sup>d, e</sup>			260		

IMERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b, f	t ≤ 5 s	R <sub>thJA</sub>	28	36	°C/W	
Maximum junction-to-case (drain)	Steady state	R <sub>thJC</sub>	5.3	6.5	C/W	

Notes a. Package limited

b. Surface mounted on 1" x 1" FR4 board

c. t = 5 s

See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection d.

Rework conditions: manual soldering with a soldering iron is not recommended for leadless components e.

Maximum under steady state conditions is 80 °C/W f.

S12-1141-Rev. B, 21-May-12

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static			•			•	
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0, I_D = -250 \ \mu A$	-8	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	1 050 0	-	-5.8	-	mV/°C	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μΑ	-	2.4	-		
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = -250 \ \mu A$	-0.35	-	-0.8	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS}$ = 0 V, $V_{GS}$ = ± 5 V	-	-	± 100	nA	
Zoro gato voltago drain current		$V_{DS} = -8 V$ , $V_{GS} = 0 V$	-	-	-1	. uA	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS}$ = -8 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C	-	-	-10		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \leq$ -5 V, $V_{GS}$ = -4.5 V	-10	-	-	A	
		$V_{GS}$ = -4.5 V, I <sub>D</sub> = -8.2 A	-	0.0130	0.0160		
		$V_{GS}$ = -2.5 V, I <sub>D</sub> = -7.2 A	-	0.0180	0.0215		
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS}$ = -1.8 V, I <sub>D</sub> = -6.6 A	-	0.0210	0.0260	Ω	
		$V_{GS} = -1.5 \text{ V}, \text{ I}_{D} = -1 \text{ A}$	-	0.0250	0.0320	-	
		$V_{GS} = -1.2 \text{ V}, \text{ I}_{D} = -1 \text{ A}$	-	0.0370	0.0950		
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = -4 V, I_D = -8.2 A$	-	37	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>		-	2300	-	pF	
Output capacitance	C <sub>oss</sub>	$V_{DS}$ = -4 V, $V_{GS}$ = 0 V, f = 1 MHz	-	735	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	690	-		
Total gata charge	0	$V_{DS} = -4 V$ , $V_{GS} = -5 V$ , $I_{D} = -10 A$	-	33	50		
Total gate charge	Qg	g _	30	45	nC		
Gate-source charge	Q <sub>gs</sub>	$V_{DS}$ = -4 V, $V_{GS}$ = -4.5 V, $I_{D}$ = -10 A	-	3	-		
Gate-drain charge	Q <sub>gd</sub>		-	6.6	-		
Gate resistance	R <sub>g</sub>	f = 1 MHz	2	9	18	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	20	30		
Rise time	t <sub>r</sub>	$V_{DD} = -4 V, R_L = 0.4 \Omega,$	-	20	30	20	
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong$ -9.8 A, $V_{GEN}$ = -4.5 V, $R_g$ = 1 $\Omega$	-	70	105	ns	
Fall time	t <sub>f</sub>		-	40	60		
Drain-Source Body Diode Characteria	stics						
Continuous source-drain diode current	I <sub>S</sub>			-	-12	^	
Pulse diode forward current	I <sub>SM</sub>			-	-50	A	
Body diode voltage	V <sub>SD</sub>	$I_{\rm S}$ = -9.8 A, $V_{\rm GS}$ = 0 V	-	-0.8	-1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	40	80	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = -9.8 A, di/dt = 100 A/μs,	-	12	25	nC	
Reverse recovery fall time	t <sub>a</sub>	$T_J = 25 \ ^{\circ}C$	-	14	-		
Reverse recovery rise time	t <sub>b</sub>		-	26	-	ns	

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

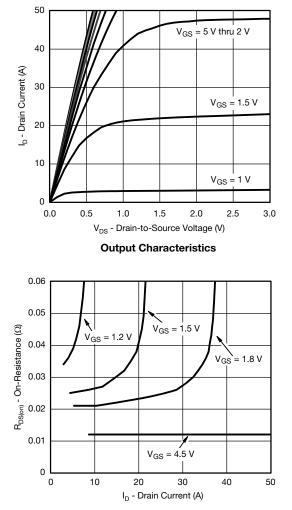
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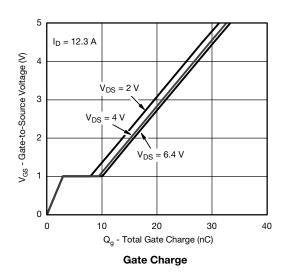


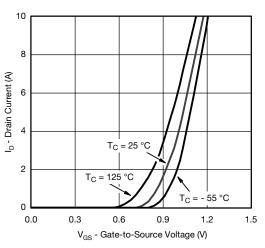
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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

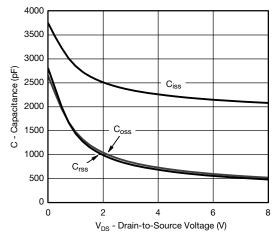


**On-Resistance vs. Drain Current and Gate Voltage** 

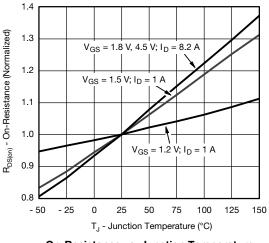




Transfer Characteristics



Capacitance



**On-Resistance vs. Junction Temperature** 

S12-1141-Rev. B, 21-May-12

3

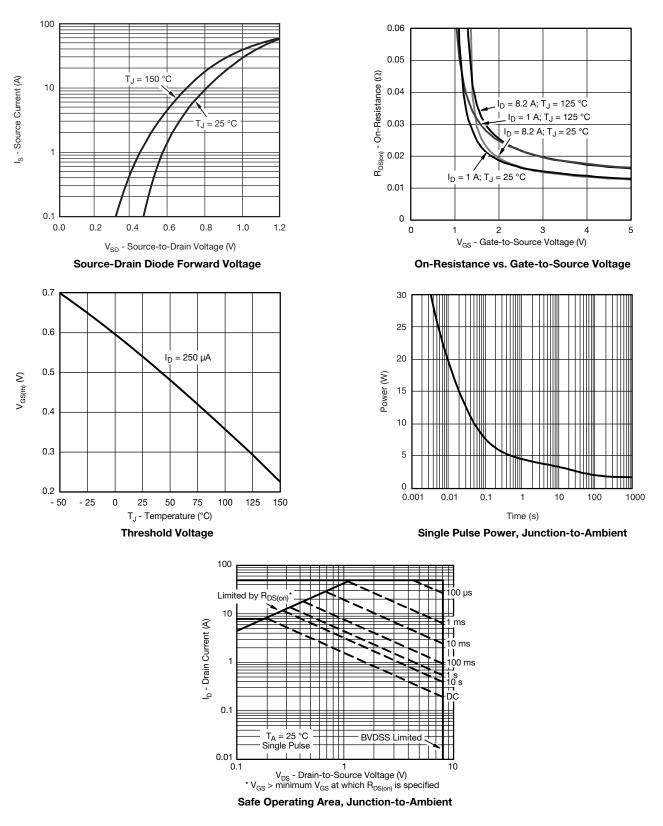
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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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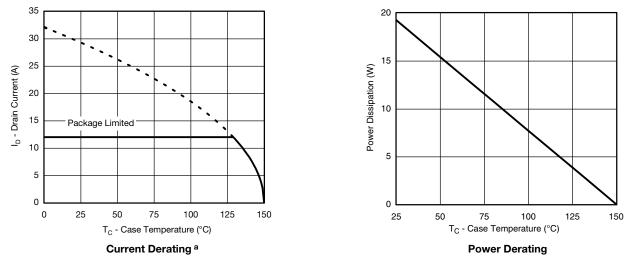
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SiA427ADJ

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



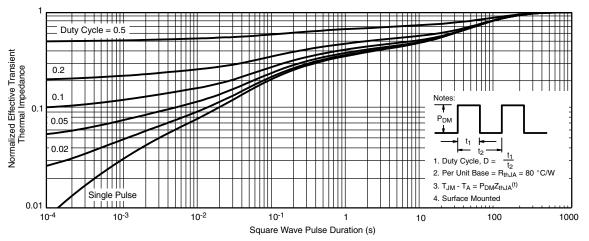
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

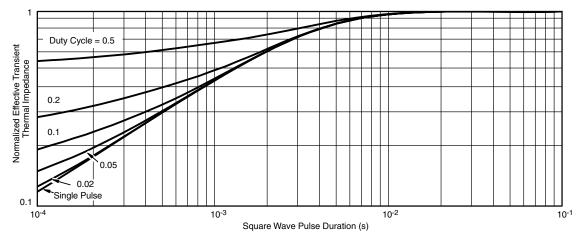


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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



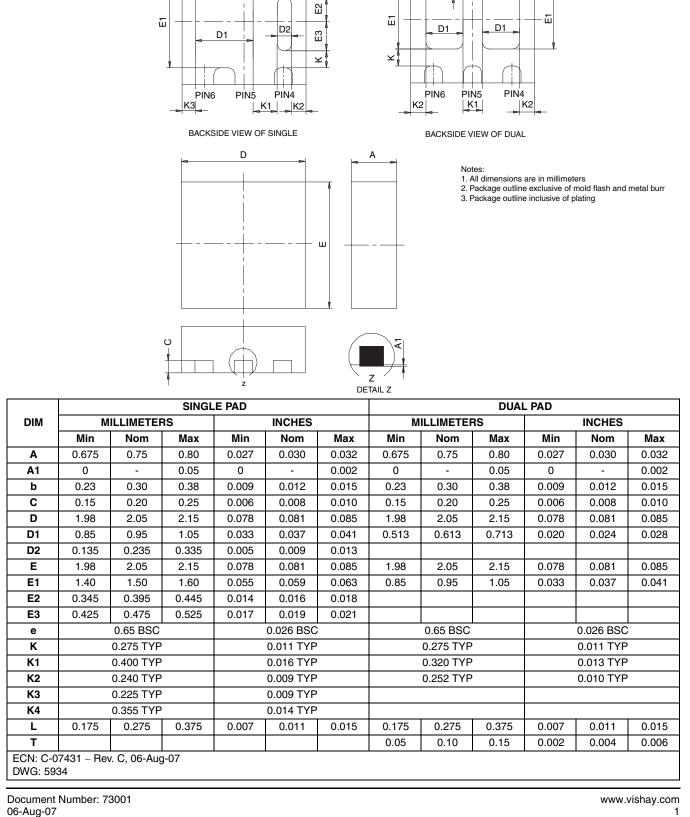
Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?63651">www.vishay.com/ppg?63651</a>.

S12-1141-Rev. B, 21-May-12	6	Document Number: 63651		
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b

PIN3

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PIN2

PIN1

# **Package Information**

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PIN3

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PIN2

PIN1

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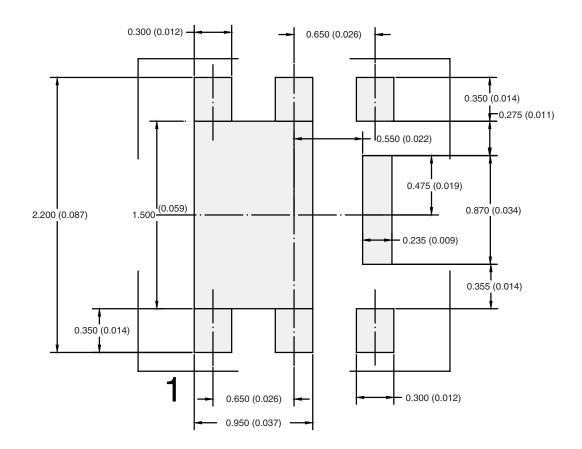
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VISHA

PowerPAK<sup>®</sup> SC70-6L



## RECOMMENDED PAD LAYOUT FOR PowerPAK<sup>®</sup> SC70-6L Single



Dimensions in mm/(Inches)

Return to Index

APPLICATION NOTE



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